

HTCC-AB01_V2

LoRa Node Development Kit



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Document version

Version	Time	Description	Remark
V1.0	2022-08-16	Documents creating	肖鸿
V1.1	2022-09-21	Document structure update	Aaron



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1. Description

1.1 Overview

HTCC-AB01 is <u>Cubecell(TM)</u> Series made by Heltect team, mainly for LoRa/LoRaWAN node applications.

HTCC-AB01 is based on ASR6052, the chip is already integrated with the PSoC® 4000 series MCU (ARM® Cortex® M0+ Core) and SX1262. We have done a lot of migration and development, made it perfectly support Arduino®, can run the LoRaWAN protocol stably, can easily connect lithium batteries and solar panels. HTCC-AB01 is a Dev-Board. Friendly designed for developers, easy to verify communication solutions.

HTCC-AB01 product model list:

Table 1.1: Product model list

No.	Model	Description			
4	LITCC ADOLLE	470~510MHz working LoRa frequency, used for			
1	HTCC-AB01-LF	China mainland (CN470) LPW band.			
	HTCC-AB01-HF	For EU868, IN865, US915, AU915, AS923, KR920 and			
2		other LPW networks with operating frequencies			
		between 863~928MHz.			

1.2 Product features

- Perfect <u>Arduino-Compatible</u>;
- CE and FCC certification;
- Based on ASR605x (ASR6501, ASR6502), those chips are already integrated the PSoC® 4000 series MCU (ARM® Cortex® M0+ Core) and SX1262;

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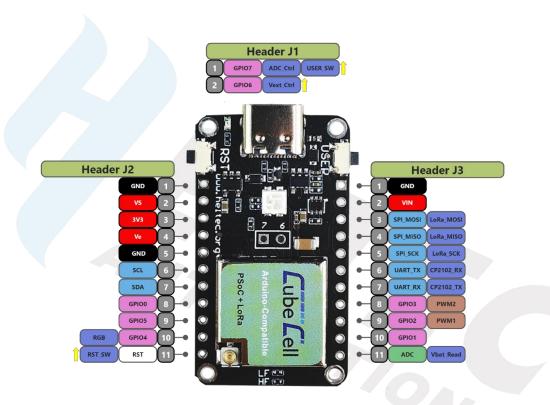


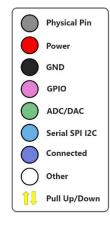
- LoRaWAN 1.0.2 support;
- Ultra low power design, 3.5uA in deep sleep;
- Onboard solar energy management system, can directly connect with a 5.5~7V solar panel;
- Onboard SH1.25-2 battery interface, integrated lithium battery management system (charge and discharge management, overcharge protection, battery power detection, USB / battery power automatic switching);
- Micro USB interface with complete ESD protection, short circuit protection, RF shielding, and other protection measures;
- Integrated CP2102 USB to serial port chip, convenient for program downloading, debugging information printing;
- ➤ Good impendence matching and long communication distance.



2. Pin Definition

2.1 Pin assignment





HTCC-AB01_V2 Pin map



2.2 Pin description

• Header J1

Table 2.2-1: Pin description

No.	Name	Type Function	
1	7	I/O	GPIO7, VBAT_ADC_CTL, USER_KEY.
2	6	I/O	GPIO6, Vext enable.

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Header J2

Table 2.2-2: Pin description

No.	Name	Туре	Function	
1	GND	Р	Ground	
2	VS	Р	Solar energy input	
3	3V3	Р	3.3V power supply	
4	Ve	Р	External power supply output	
5	GND	Р	Ground	
6	SCL	I/O	I2C_SCL	
7	SDA	I/O	I2C_SDA	
8	0	I/O	GPIO0	
9	5	I/O	GPIO5	
10	4	I/O	GPIO4, RGB_Ctrl	
11	RST	I	RESET	

Header J3

Table 2.2-3: Pin description

No.	Name	Туре	Function		
1	GND	Р	Ground		
2	VIN	Р	5V power supply		
3	MO	I/O	Internal connection to LoRa_MOSI		
4	MI	I/O	Internal connection to LoRa_MISO		
5	SCK	I/O	Internal connection to LoRa_SCK		

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6	TX	I/O	UART_TX. Connect to USB bridge chip			
7	RX	I/O	UART_TX. Connect to USB bridge chip			
8	3	I/O	GPIO3			
9	2	1/0	GPIO2			
10	1	I/O	GPIO1			
11	ADC	I	ADC_IN2 ¹			

3. Specifications

3.1 General specifications

Table 3.1: General specifications

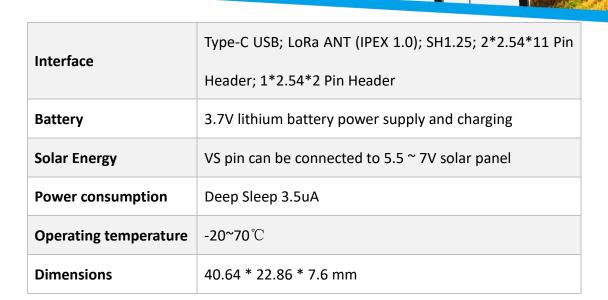
Parameters	Description
Master Chip	ASR6502 (48 MHz ARM® Cortex® M0+ MCU)
LoRa Chipset	SX1262
Frequency	470~570MHz, 863~928MHz
Max TX Power	21±1dBm
Receiving sensitivity	-134dBm
USB to Serial Chip	CP2102
Hardware Resource	1*SPI; 1*I2C; 1*UART; 1*12-bit ADC; 1*SWD; 8*GPIO;
naiuware Resource	2*PWM; 8-Channel DMA engine
Memory	128Kbites FLASH; 16Kbites SRAM

¹ ADC_IN2 for external ADC; ADC_IN1 is used to read the lithium battery voltage, the voltage of the lithium battery is:

 $V_{BAT} = 2*V_{ADC_IN1}$

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3.2 Power supply

Except when USB or 5V Pin is connected separately, lithium battery can be connected to charge it. In other cases, only a single power supply can be connected.

Table 3.2: Power supply

Power supply mode	Minimum	Typical	Maximum	Company
Type-C USB(≥500mA)	4.7	5	6	V
Lithium battery(≥250mA)	3.3	3.7	4.2	V
5V pin(≥500mA)	4.7	5	6	V
3V3 pin(≥150mA)	2.7	3.3	3.5	V

3.3 Power output

Table 3.3: Power output

Output Pin	Minimum	Typical	Maximum	Company
3.3V Pin			500	mA



3.4 Power characteristics

Table 3.4: Power characteristics

Mode	Condition	Min.	Typical	Max.	Company
тх	14dBm, USB powered, 868		150		mA
	17dBm, USB powered, 868		170		mA
	22dBm, USB powered, 868		185		mA
RX	TX disabled; RX enabled		30		mA
sleep	USB powered		10		mA
	VBAT/battery powered		11		uA
	3.3V header powered		3.5		uA

3.5 LoRa RF characteristics

3.5.1 Transmit power

Table3.5.1: Transmit power

Operating frequency band	Maximum power value/[dBm]
470~510	21 ± 1
867~870	21 ± 1
902~928	21 ± 1



3.5.2 Receiving sensitivity

The following table gives typically sensitivity level of the HTCC-AB01.

Table3.5.2: Receiving sensitivity

Signal Bandwidth/[KHz]	Spreading Factor	Sensitivity/[dBm]
125	SF12	-134
125	SF10	-130
125	SF7	-122

3.6 Operation Frequencies

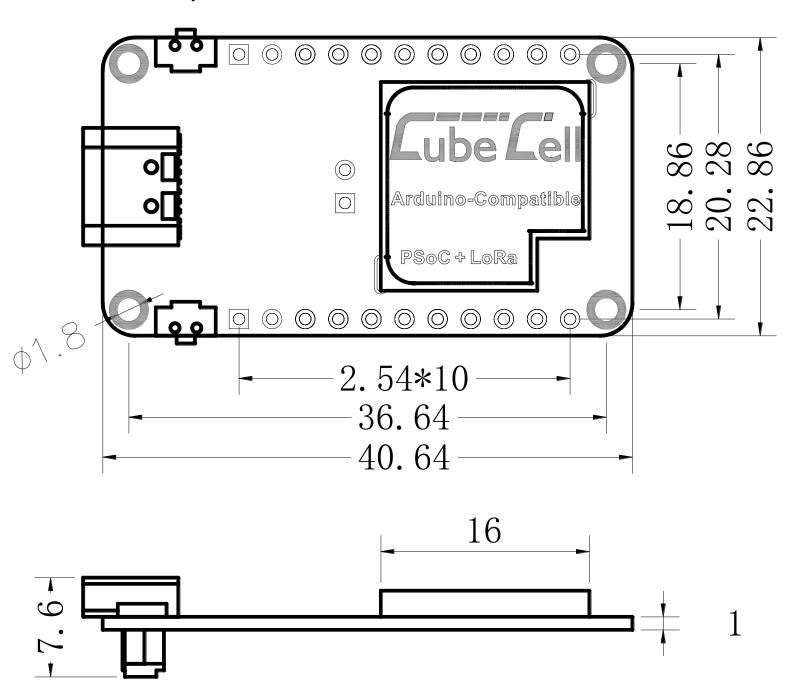
HTCC-AB01 supports LoRaWAN frequency channels and models corresponding table.

Table3.6: Operation Frequencies

Region	Frequency (MHz)	Model
EU433	433.175~434.665	HTCC-AB01-LF
CN470	470~510	HTCC-AB01-LF
IN868	865~867	HTCC-AB01-HF
EU868	863~870	HTCC-AB01-HF
US915	902~928	HTCC-AB01-HF
AU915	915~928	HTCC-AB01-HF
KR920	920~923	HTCC-AB01-HF
AS923	920~925	HTCC-AB01-HF



4.1 Physical dimensions



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5. Resource

5.1 Relevant Resource

- Source Code
 - Cubecell-Arduino framework
- Schematic diagram
- Pin map
- <u>Downloadable resource</u>

5.2 Contact Information

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